

# PARA LIGHT ELECTRONICS CO., LTD.

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# DATA SHEET

PART NO.: L-S11F1RGBCT-CC

REV: A / 0

CUSTOMER'S APPROVAL:

DCC:

DRAWING NO.: DS-80-19-0002G

DATE:2019-03-15

**PAGE** 

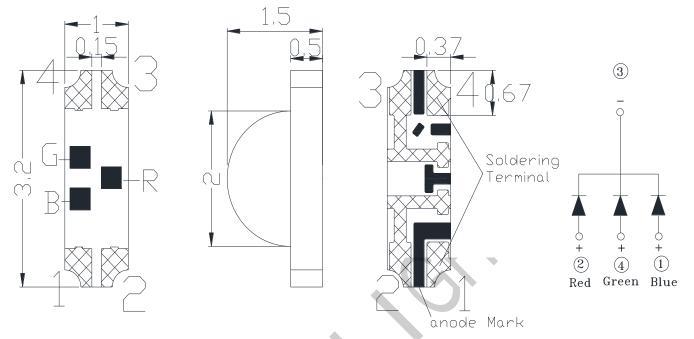
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Part No.:L-S11F1RGBCT-CC

REV:A/0

#### PACKAGE OUTLINE DIMENSIONS



#### Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.1mm (.004") unless otherwise noted.

#### Features

- \* Three color, side view, wide view angle Chip LED.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic Pick & Place equipment.
- \* Compatible with Reflow soldering and Wave soldering processes.
- \* EIA STD package.
- \* I.C. compatible.
- \* Pb free product.
- \* Moisture sensitivity level: 3

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REV:A/0

# Chip Materials

Light Color	Dice Material	Lens Color
R: Red	AlInGap	
G: Green	InGaN	Water Clear
B: Blue	InGaN	

# ● Absolute Maximum Ratings (Ta=25°C)

CVMDOL	PARAMETER		Rating	LINIT	
SYMBOL	PARAMETER	R	G	В	UNIT
$P_{\mathrm{D}}$	Power Dissipation	75	100	100	mW
$V_R$	Reverse Voltage		5	V	
IF	Continuous Forward Current	25	25	25	mA
Ipf	Peak Forward Current	80	100	100	mA
ESD	Electrostatic Discharge Threshold (HBM) <sup>Note A</sup>	/	/	1000	V
Topr	Operating Temperature Range	-40 ~ +85		5	$^{\circ}\mathbb{C}$
Tstg	Storage Temperature Range	-40 ~ +85			$^{\circ}\mathrm{C}$

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD

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# • Electro-Optical Characteristics (Ta=25°C)

SYMBOL		PARAMETER	TEST	MIN.	TYP.	MAX.	UNIT
	R		IF = 10mA	1.8		2.3	V
VF	G	Forward Voltage		2.5		3.0	
	В			2.6		3.1	
	R			112		280	
IV	G	Luminous Intensity	IF = 10mA	180		710	mcd
	В			45		180	
	R				620		
λD	G	Dominant Wavelength	IF = 10mA		520		nm
	В				465		
	R				17		
Δλ	G	Spectral Line Half-Width	IF = 10mA		15		nm
	В				25		
	R				630		
λр	G	Peak Emission Wavelength	IF = 10mA		520		nm
	В				468		
2θ1/2		Half Intensity Angle	IF = 10mA		130		deg
IR	R	Reverse Current	VR = 5V			10	
	G					50	μΑ
	В					50	

#### Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:
  - Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

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### Part No.:L-S11F1RGBCT-CC

REV:A/0

# Red Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

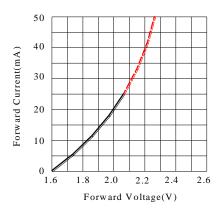


Fig.2 Forward Current vs.Forward Voltage

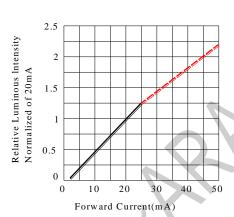


Fig.4 Relative Luminous Intensity vs.Forward Current

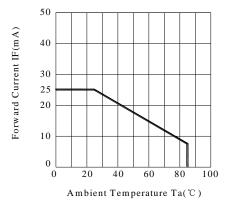


Fig.6 Forward Current Derating Curve

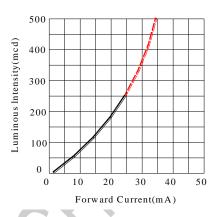


Fig.3 Luminous Intensity vs.Forward Current

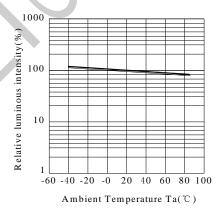


Fig.5 Luminous Intensity vs. Ambient Temperature

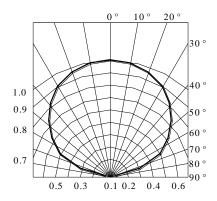


Fig.7 Relative Intensity vs.Angle

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### Part No.:L-S11F1RGBCT-CC

REV:A/0

### Green Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

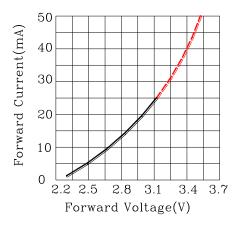


Fig.2 Forward Current vs.Forward Voltage

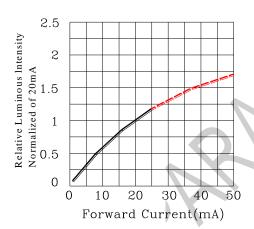


Fig.4 Relative Luminous Intensity vs.Forward Current

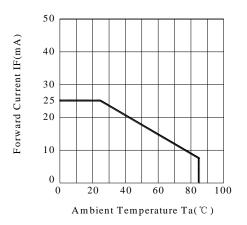


Fig.6 Forward Current Derating Curve

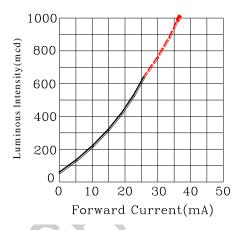


Fig.3 Luminous Intensity vs.Forward Current

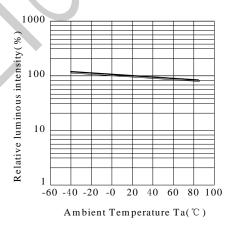


Fig.5 Luminous Intensity vs.Ambient Temperature

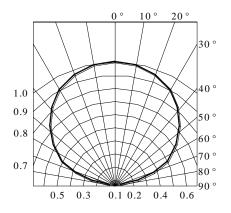


Fig.7 Relative Intensity vs.Angle

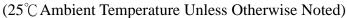
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### Part No.:L-S11F1RGBCT-CC

REV:A/0

### Blue Typical Electro-Optical Characteristics Curves



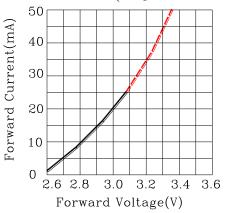


Fig.2 Forward Current vs.Forward Voltage

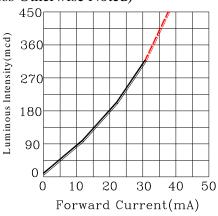


Fig.3 Luminous Intensity vs.Forward Current

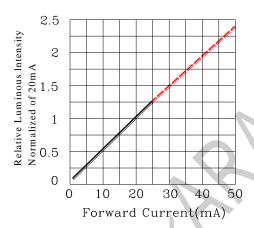


Fig.4 Relative Luminous Intensity vs.Forward Current

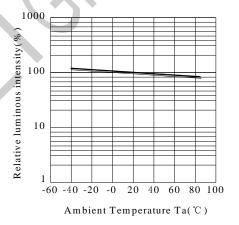


Fig.5 Luminous Intensity vs. Ambient Temperature

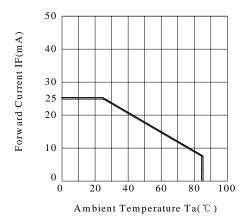


Fig.6 Forward Current Derating Curve

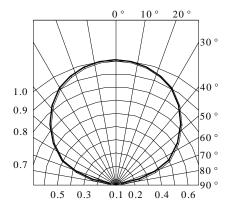


Fig.7 Relative Intensity vs.Angle

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Part No.:L-S11F1RGBCT-CC

REV:A/0

#### Label Explanation



#### ITEM CODE:PARA LIGHT

#### PART NO:L-S11F1RGBCT-CC

IV --- Luminous Intensity Code

LOT NO: <u>EM S L 12 09</u> 0110 A B C D E F

A---EM: Emos Code

B---S:SMD

C---Local

D---Year

E---Month

F---SPEC.

#### PACKING QUANTITY OF BAG:

3000pcs for 150, 170, 110, 155, 115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10

G H I

G--- Year

H--- Month

I --- Day

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## Part No.:L-S11F1RGBCT-CC

REV:A/0

## Typical Electro-Optical Characteristics Curves

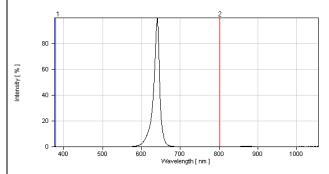


Fig.1 Red Relative Intensity vs. Wavelength

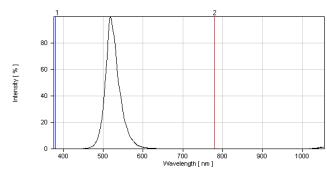


Fig.1 Green Relative Intensity vs. Wavelength

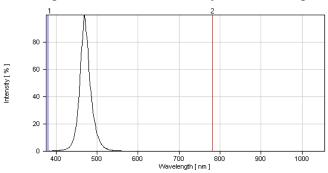
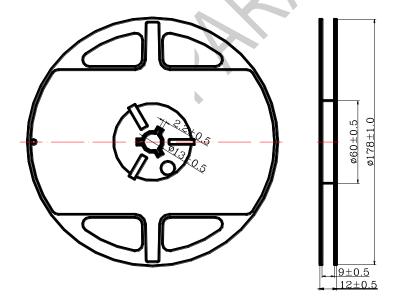


Fig.1 Blue Relative Intensity vs. Wavelength

#### Reel Dimensions



#### Notes:

- 1. Taping Quantity: 3000pcs
- 2. The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5^{\circ}$ , Unit: mm.

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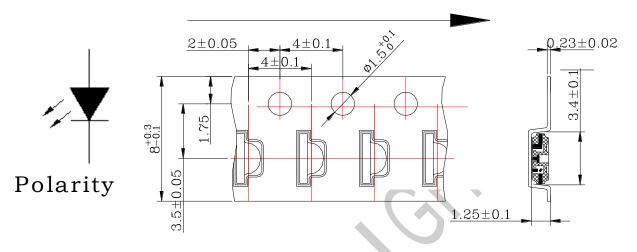


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# Package Dimensions Of Tape And Reel

# Progressive direction



Notes: All dimensions are in millimeters.

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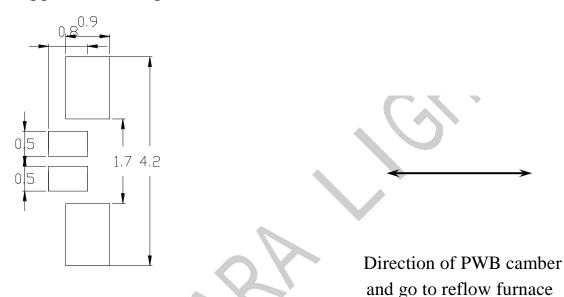
Part No.:L-S11F1RGBCT-CC

REV:A/0

### Cleaning

- \* If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

## Suggest Soldering Pad Dimensions



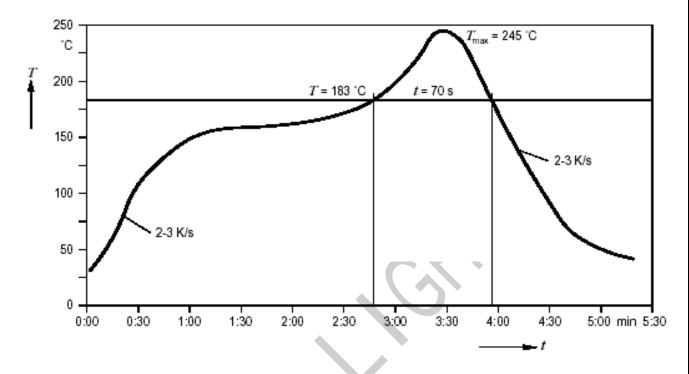
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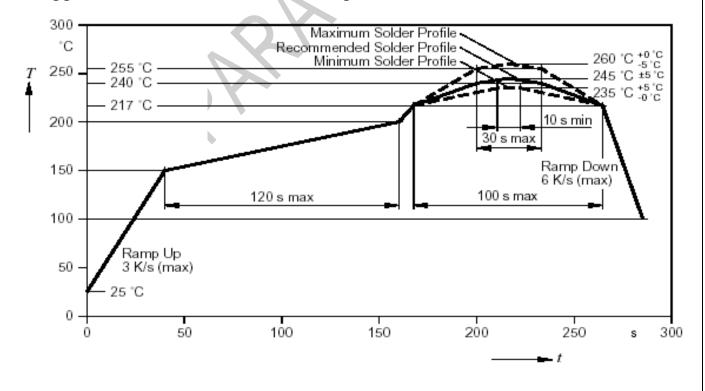
Part No.:L-S11F1RGBCT-CC

REV:A/0

### • Suggest Sn/Pb IR Reflow Soldering Profile Condition:



### • Suggest Pb-Free IR Reflow Soldering Profile Condition:



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Part No.:L-S11F1RGBCT-CC

REV:A/0

#### Bin Code List

Luminous Intensity (IV), Unit: mcd@10mA								
Red (a chip)				Green (b chip	))	Blue (c chip)		
Bin Code	Min	Max	Bin Code	Min	Max	Bin Code	Min	Max
R	112	180	Т	280	450	P	45	71
S	180	280	U	450	710	Q	71	112

Tolerance of each bin are  $\pm 15\%$ 

Dominant Wavelength (Hue), Unit: nm@10mA							
	Green (b chip)		Blue (c chip)				
Bin Code	Min	Max	Bin Code Min Ma				
AO	515	520	AB	460	465		
AP	520	525	AC	465	470		

Tolerance of each bin are  $\pm 1$ nm

### **CAUTIONS**

#### 1. Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

#### 2.Storage:

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

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#### 3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150 ℃, 120sec. MAX., Peak temperature: 240 ℃ Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering:

Pre-heat 100 °C Max, Pre-heat time 60 sec. Max, Solder wave 260 °C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between  $1^{st}$  and  $2^{nd}$  soldering processes.

#### 4. Lead-Free Soldering

For Reflow Soldering:

- 1 · Pre-Heat Temp:150-180°C,120sec.Max.
- 2 Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3 ` Peak Temperature:  $260^{\circ}\text{C}$  ' 5sec.
- 4 \ Reflow Repetition: 2 Times Max.
- 5 \ Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

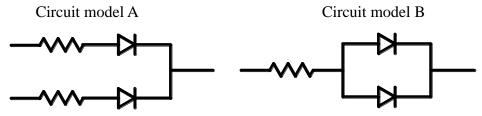
For Soldering Iron (Not Recommended):

- 1 \ Iron Tip Temp:350°C Max.
- 2 Soldering Iron:30w Max.
- 3 Soldering Time: 3 Sec. Max. One Time.

#### For Dip Soldering:

- 1 \ Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2 Sath Temp:265°C Max.
- 3 \ Dip Time: 5 Sec. Max.

#### 5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

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